



NOT RECOMMENDED FOR NEW DESIGNS USE MMDT3906VC

MMDT3906V

May 2009

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DUAL PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Notes 4 and 5)

Mechanical Data

Case: SOT-563

Case Material: Molded Plastic, "Green" Molding Compound.
 (Note 5) UL Flammability Classification Rating 94V-0

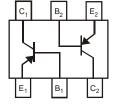
Moisture Sensitivity: Level 1 per J-STD-020D

Terminal Connections: See Diagram

- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe.
 Solderable per MIL-STD-202, Method 20
- Terminals: Lead bearing terminal plating available. See Ordering information Page 3
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.003 grams (approximate)







Top View

Bottom View

Device Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current - Continuous	Ic	-200	mA

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 3) @ $T_A = 25^{\circ}C$	P_{D}	150	mW
Thermal Resistance, Junction to Ambient	(Note 3) @ $T_A = 25^{\circ}C$	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes:

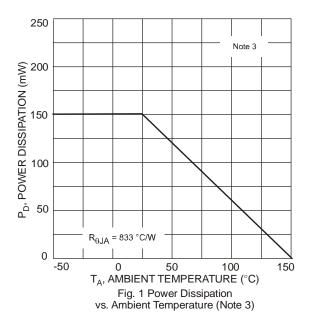
- 1. No purposefully added lead.
- 2. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated, or mixed (both ways).
- 3. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

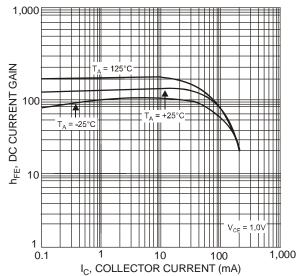


Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)					
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-40		V	$I_C = -10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-40	_	V	$I_C = -1.0 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5.0	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cutoff Current	I _{CEX}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
Base Cutoff Current	I _{BL}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
ON CHARACTERISTICS (Note 6)					
DC Current Gain	h _{FE}	60 80 100 60 30	 300 	_	$I_{C} = -100\mu A, V_{CE} = -1.0V$ $I_{C} = -1.0mA, V_{CE} = -1.0V$ $I_{C} = -10mA, V_{CE} = -1.0V$ $I_{C} = -50mA, V_{CE} = -1.0V$ $I_{C} = -100mA, V_{CE} = -1.0V$
Collector-Emitter Saturation Voltage	V _{CE} (SAT)	_	-0.25 -0.40	V	$I_C = -10$ mA, $I_B = -1.0$ mA $I_C = -50$ mA, $I_B = -5.0$ mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.65 —	-0.85 -0.95	V	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}	_	4.5	pF	$V_{CB} = -5.0V$, $f = 1.0MHz$, $I_E = 0$
Input Capacitance	C _{ibo}		10	pF	$V_{EB} = -0.5V$, $f = 1.0MHz$, $I_C = 0$
Input Impedance	h _{ie}	2.0	12	kΩ	
Voltage Feedback Ratio	h _{re}	0.1	10	x 10 ⁻⁴	$V_{CE} = 10V, I_{C} = 1.0mA,$
Small Signal Current Gain	h _{fe}	100	400	_	f = 1.0kHz
Output Admittance	h _{oe}	3.0	60	μS	
Current Gain-Bandwidth Product	f⊤	250		MHz	$V_{CE} = -20V, I_{C} = -10mA,$ f = 100MHz
Noise Figure	NF		4.0	dB	V_{CE} = -5.0V, I_{C} = -100μA, R_{S} = 1.0kΩ, f = 1.0kHz
SWITCHING CHARACTERISTICS				•	
Delay Time	t _d	_	35	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
Rise Time	t _r		35	ns	$V_{BE(off)} = 0.5V, I_{B1} = -1.0mA$
Storage Time	ts		225	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
Fall Time	t _f		75	ns	$I_{B1} = I_{B2} = -1.0 \text{mA}$

Notes: 6. Short duration pulse test used to minimize self-heating effect.



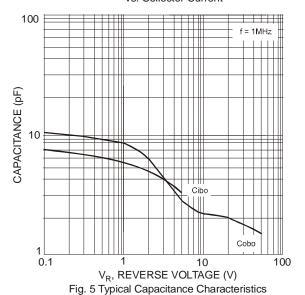


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$V_{CE(SAT)}$, COLLECTOR-EMITTER (V) SATURATION VOLTAGE 0.01 100 1,000 I_C , COLLECTOR CURRENT (mA)

Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current



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MMDT3906V

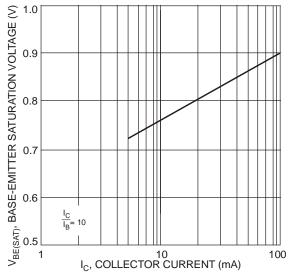


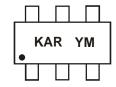
Fig. 4 Typical Base-Emitter Saturation Voltage vs. Collector Current

Ordering Information (Note 7)

Part Number	Case	Packaging		
MMDT3906V-7	SOT-563	3000/Tape & Reel		

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



KAR = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006)M = Month (ex: 9 = September)

Date Code Key

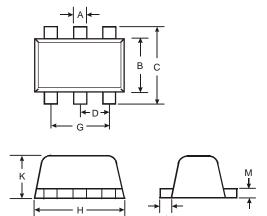
Year	2005	2006	2007	2008	200	9 20	010	201	1 :	2012	2013	2014	2015
Code	S	T	U	V	W		Χ	Υ		Z	Α	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jı	ıl	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	7	8	9	0	N	D

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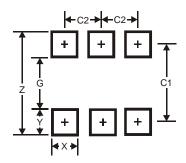


Package Outline Dimensions



SOT-563						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.20			
В	1.10	1.25	1.20			
С	1.55	1.70	1.60			
D	D -		0.50			
G	0.90	1.10	1.00			
H 1.50		1.70	1.60			
K	0.55	0.60	0.60			
L	0.10	0.30	0.20			
M	0.10	0.18	0.11			
All	All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
Co	0.5



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